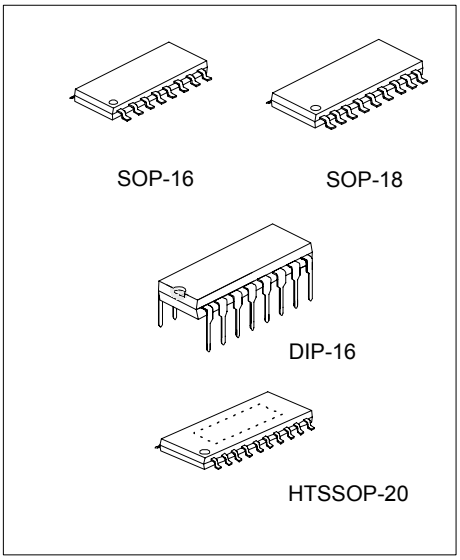
DUAL 2.2W AUDIO AMPLIFIER PLUS STEREO HEADPHONE FUNCTION



*Pb-free plating product number: L4863L

■ DESCRIPTION

The UTC **L4863** is a dual bridge-connected audio power amplifier. It combines dual bridge speaker amplifiers and stereo headphone amplifiers on one chip to simplify audio system design. In addition, the headphone input pin allows the amplifiers to operate in single-ended mode when driving stereo headphones.

The IC could deliver different power by packages as below (when connected to a 5V supply with less than 1.0% THD+N.):

- HTSSOP-20, 4Ω load: 2.2W
- HTSSOP-20, 3Ω load: 2.5W(with forced-air cooled)
- SOP/DIP , 8Ω load: 1.1W.

The UTC **L4863** features an externally controlled, low-power consumption shutdown mode, a stereo headphone amplifier mode, and thermal shutdown protection. It also utilizes circuitry to reduce “clicks and pops” during device turn-on.

■ FEATURES

* “Click and pop” suppression
* Thermal shutdown protection
* Unity-gain stable
* Stereo headphone amplifier mode

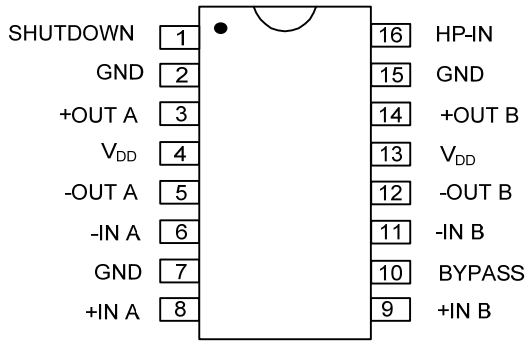
■ ORDERING INFORMATION

Order Number		Package	Packing
Normal	Lead Free Plating		
L4863-D16-T	L4863L-D16-T	DIP-16	Tube
L4863-S16-R	L4863L-S16-R	SOP-16	Tape Reel
L4863-S16-T	L4863L-S16-T	SOP-16	Tube
L4863-S18-R	L4863L-S18-R	SOP-18	Tape Reel
L4863-S18-T	L4863L-S18-T	SOP-18	Tube
L4863-N20-R	L4863L-N20-R	HTSSOP-20	Tape Reel
L4863-N20-T	L4863L-N20-T	HTSSOP-20	Tube

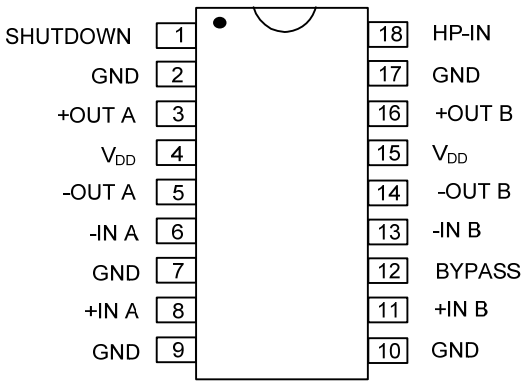
LM4863L-D16-T (1)Packing Type (2)Package Type (3)Lead Plating	(1) R: Tape Reel, T: Tube (2) D16: DIP-16, S16: SOP-16, S18: SOP-18, N20: HTSSOP-20 (3) L: Lead Free Plating, Blank: Pb/Sn

■ PIN CONFIGURATION

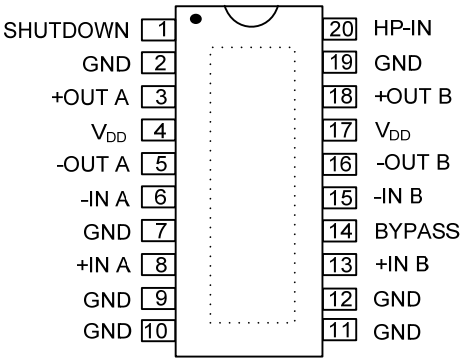
DIP-16
SOP-16



SOP-18



HTSSOP-20



■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Thermal resistance (Junction to Ambient)	SOP-16	θ_{JA}	80	℃/W
	SOP-18		90	℃/W
	DIP-16		63	℃/W
	HTSSOP-20		90	℃/W
Thermal resistance (Junction to Case)	SOP-16	θ_{JC}	20	℃/W
	SOP-18		2	℃/W
	DIP-16		20	℃/W
	HTSSOP-20		2	℃/W

■ ABSOLUTE MAXIMUM RATING

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage	V_{DD}	6.0	V
Recommended Supply Voltage Range	V_{DD}	2.0 ~ 5.5	V
Input Voltage	V_{IN}	-0.3 ~ V_{DD}+0.3	V
Power Dissipation	P_D	Internally limited	
Junction Temperature	T_J	+125	℃
Operating Temperature	T_{OPR}	-40 ~ +85	℃
Storage Temperature	T_{STG}	-65 ~ +150	℃

Note Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ ELECTRICAL CHARACTERISTICS (Notes 1)(V_{DD}=5V, Ta =25℃, unless otherwise specified)

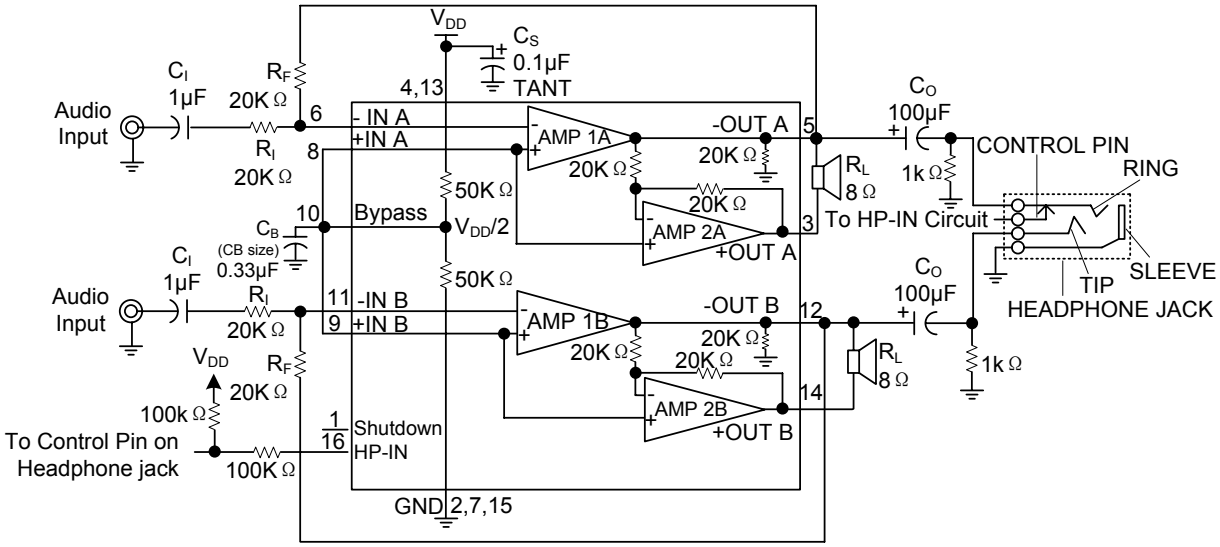
PARAMETER		SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT
FOR ENTIRE IC								
Supply Voltage		V_{DD}			2		5.5	V
Quiescent Power Supply Current (Note 2)		I_{DD}	V_{IN}=0V, I_{OUT}=0A, HP-IN=0V		6	11.5	20	mA
			V_{IN}=0V, I_{OUT}=0A, HP-IN=4V			5.8		
Shutdown Current		I_{SD}	V_{DD} applied to the SHUTDOWN pin		2	0.7		μA
Headphone Input Voltage	High	V_{IH}			4			V
	Low	V_{IL}					0.8	V
FOR BRIDGED-MODE OPERATION								
Output Offset Voltage		$V_{O(OFF)}$	V_{IN}=0V			5	50	mV
Output Power (measured at the device terminals)	HTSSOP-20	P_{OUT}	THD=1%, f=1kHz	R_L=3Ω		2.5		W
				R_L=4Ω		2.2		
			THD+N=10%, f=1kHz	R_L=3Ω		3.2		
				R_L=4Ω		2.7		
	SOP/DIP		THD=1%, f=1kHz	R_L=8Ω	1.0	1.1		W
			THD+N=10%, f=1kHz	R_L=8Ω		1.5		
			THD+N=1%, f=1kHz, RL=32Ω			0.34		W
Total Harmonic Distortion + Noise	HTSSOP-20	THD+N	20Hz≤f≤20kHz, A_{VD}=2	R_L=4Ω, P_{OUT}=2W		0.3		%
	SOP/DIP			R_L=8Ω, P_{OUT}=1W		0.3		
Power Supply Rejection Ratio		PSRR	V_{DD}=5V, V_{RIPPLE}=200mV_{RMS}, R_L=8Ω, C_B=1.0μF			67		dB
Channel Separation		X_{TALK}	f=1kHz, C_B=1.0μF			90		dB
Signal To Noise Ratio		SNR	V_{DD}=5V, P_{OUT}=1.1W, R_L=8Ω			98		dB
FOR SINGLE-ENDED OPERATION								
Output Offset Voltage		$V_{O(OFF)}$	V_{IN}=0V			5	50	mV
Output Power		P_{OUT}	THD=0.5%, f=1kHz, R_L=32Ω		75	85		mW
			THD+N=1%, f=1kHz, R_L=8Ω			340		
			THD+N=10%, f=1kHz, R_L=8Ω			440		
Total Harmonic Distortion + Noise		THD+N	A_V=-1, P_{OUT}=75mW,20Hz≤f≤20kHz, R_L=32Ω			0.2		%
Power Supply Rejection Ratio		PSRR	C_B=1.0μF, V_{RIPPLE}=200mV_{RMS}, f=1kHz			52		dB
Channel Separation		X_{TALK}	f=1kHz, C_B=1.0μF			60		dB
Signal To Noise Ratio		SNR	V_{DD}=5V, P_{OUT}=340mW, R_L=8Ω			95		dB

Note:1. All voltages are measured with respect to the ground (GND) pins, unless otherwise specified.

2. Depends on the offset voltage when a practical load is connected to the amplifier.

3. When driving 3Ω or 4Ω and operating on a 5V supply, the HTSSOP-20 package must be mounted to the circuit board that has a minimum of 2.5 in^2 of exposed, uninterrupted copper area connected to the exposed-DAP.

■ TYPICAL APPLICATION CIRCUIT



Note: Pin out shown for DIP-16 and SOP-16 packages. Refer to the PIN CONFIGURATION for the pin out of other packages.

Figure 1.Typical Audio Amplifier Application Circuit

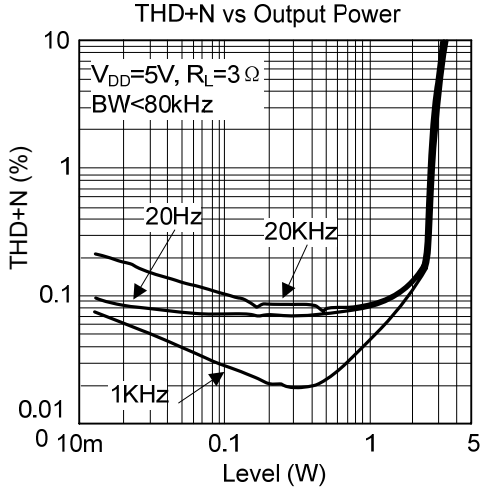
■ EXTERNAL COMPONENTS DESCRIPTION

Components	Functional Description
R_I	The inverting input resistance, along with R_F, set the closed-loop gain. R_I, along with C_I form a high pass filter with fc=1/(2 π $R_I C_I$)
C_I	The input coupling capacitor blocks DC voltage at the amplifier's input terminals. C_I, along with R_I, create a high pass filter with fc=1/(2 π $R_I C_I$). Refer to the section. Selecting Proper External Components, for an explanation of determine the value of C_I.
R_F	The feedback resistance, along with R_I, set the closed-loop gain.
C_S	The supply bypass capacitor. Refer to the Power Supply Bypassing section for information about properly placing and selecting the value of, this capacitor.
C_B	The capacitor, C_B, filters the half-supply voltage present on the Bypass pin. Refer to the Selecting Proper External Components section for information concerning proper placement and selecting C_B'S value.

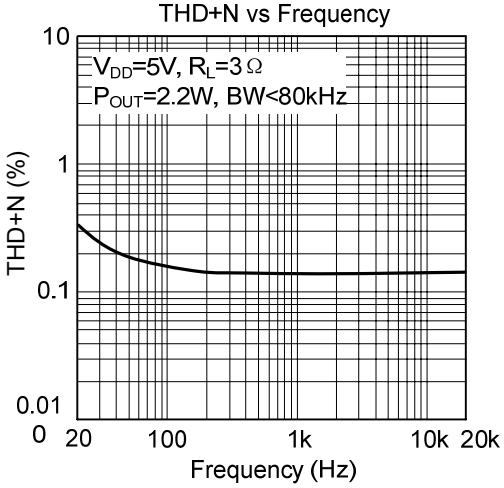
■ TYPICAL CHARACTERISTICS

(For HTSSOP-20)

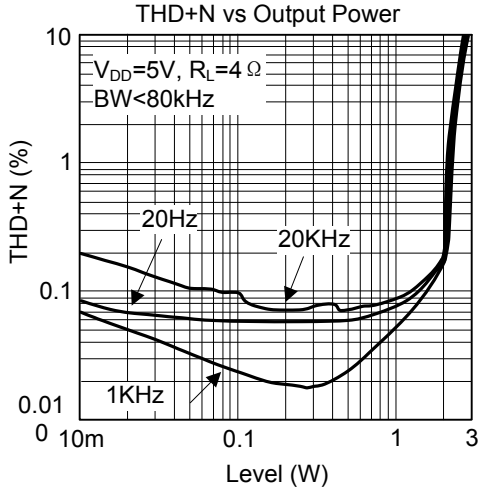
THD+N vs Output Power



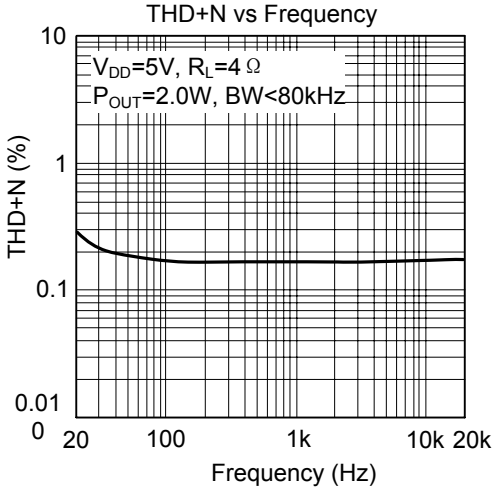
THD+N vs Frequency



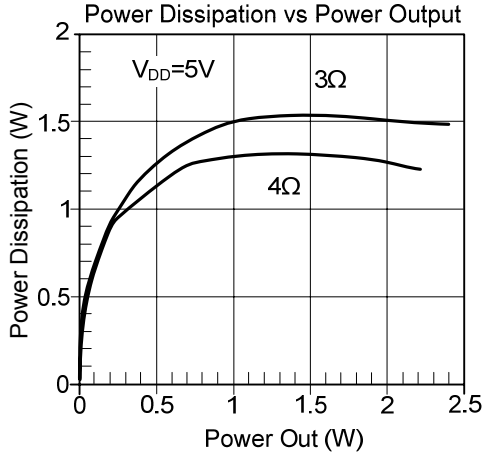
THD+N vs Output Power



THD+N vs Frequency



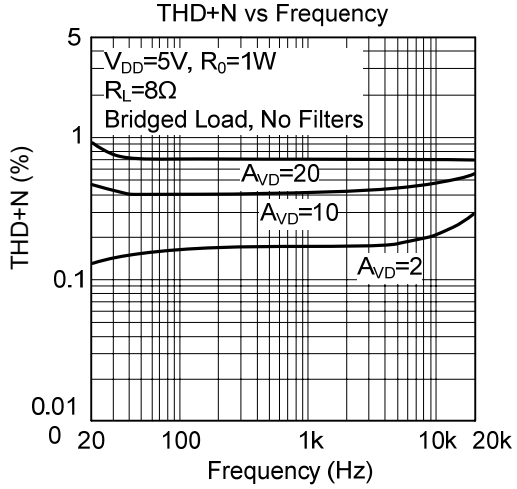
Power Dissipation vs Power Output



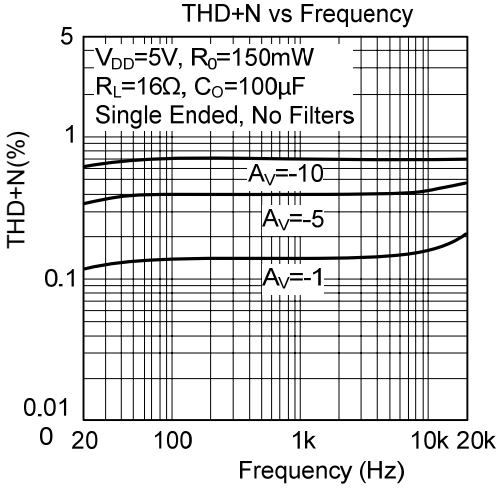
■ TYPICAL CHARACTERISTICS(Cont.)

(For DIP-16, SOP-16 and SOP-18)

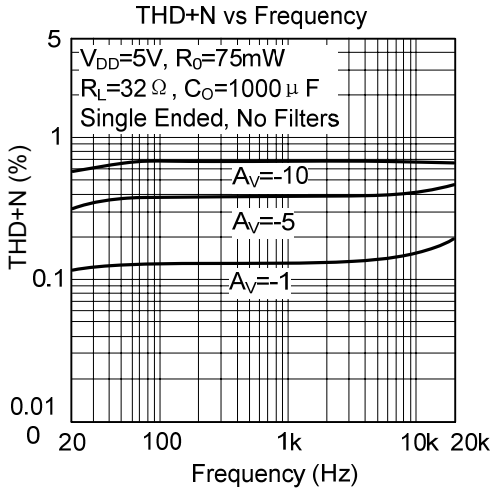
THD+N vs Frequency



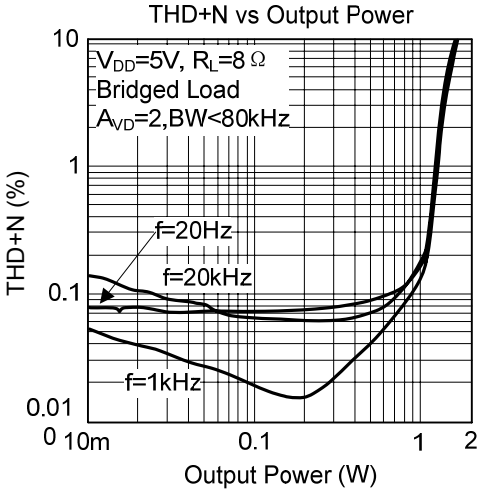
THD+N vs Frequency



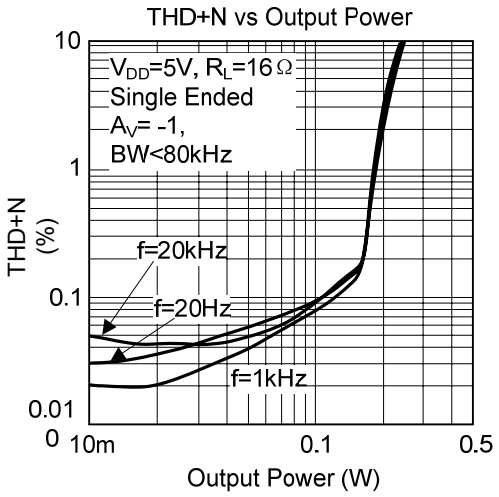
THD+N vs Frequency



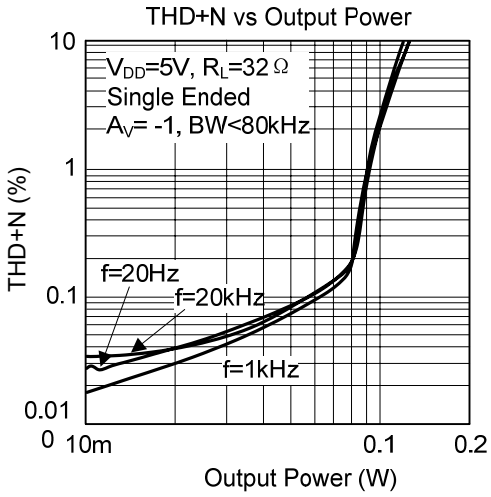
THD+N vs Output Power



THD+N vs Output Power

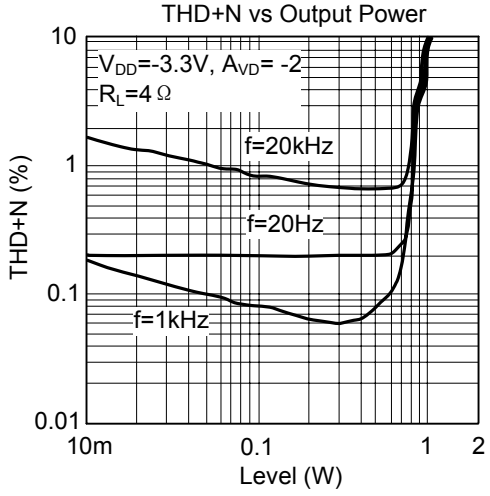


THD+N vs Output Power

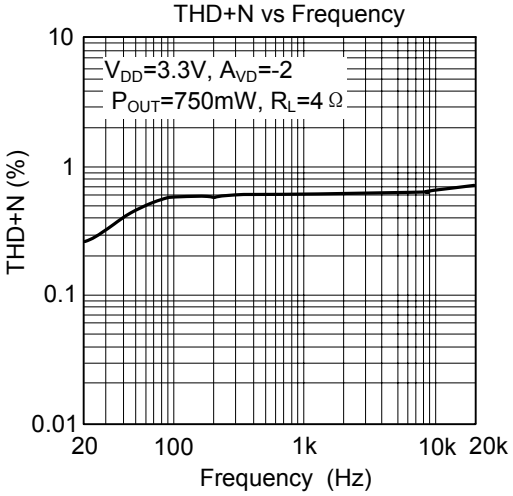


■ TYPICAL CHARACTERISTICS(Cont.)

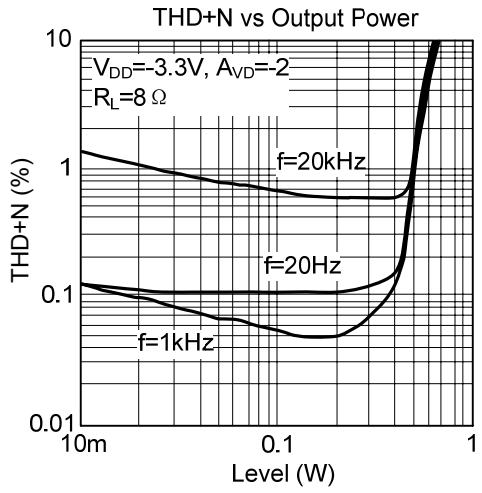
THD+N vs Output Power



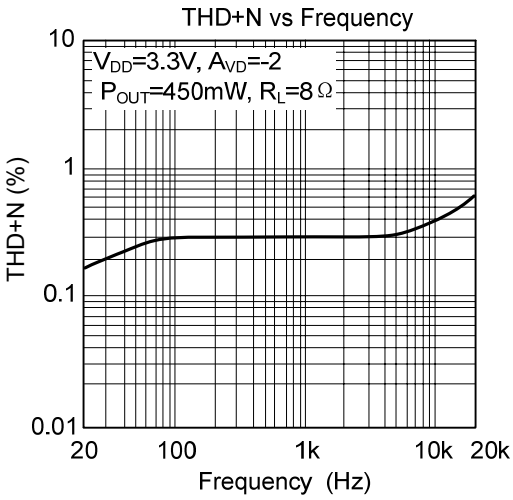
THD+N vs Frequency



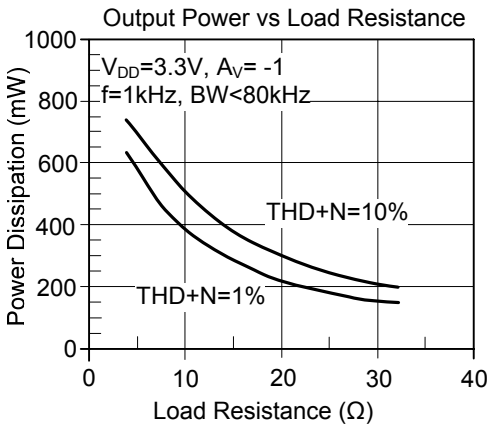
THD+N vs Output Power



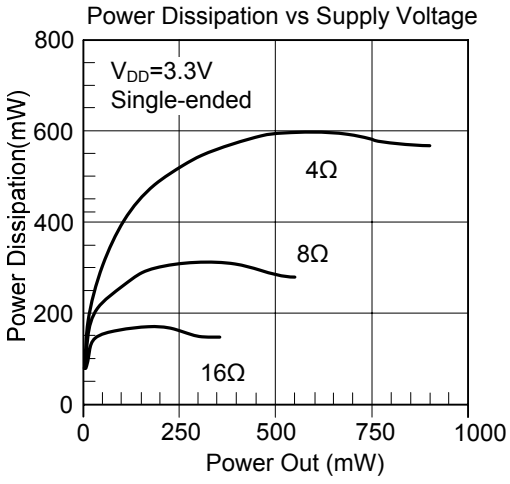
THD+N vs Frequency



Output Power vs Load Resistance



Power Dissipation vs Supply Voltage



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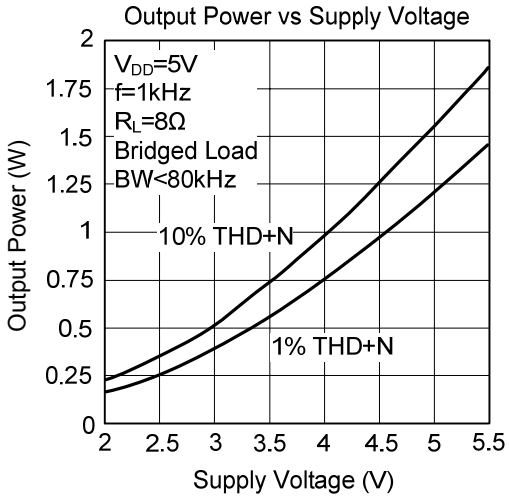
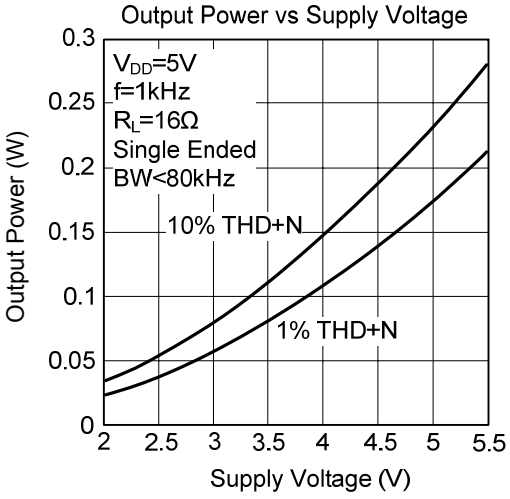
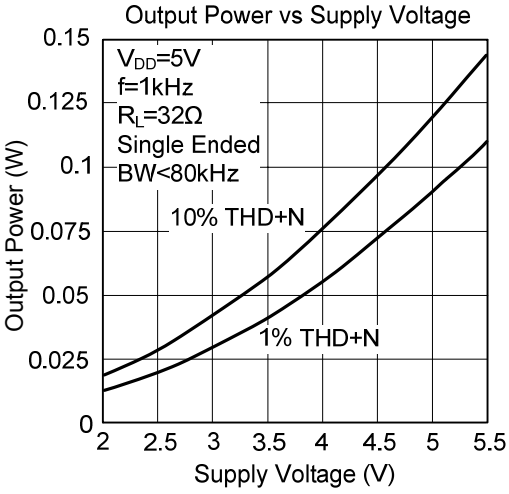
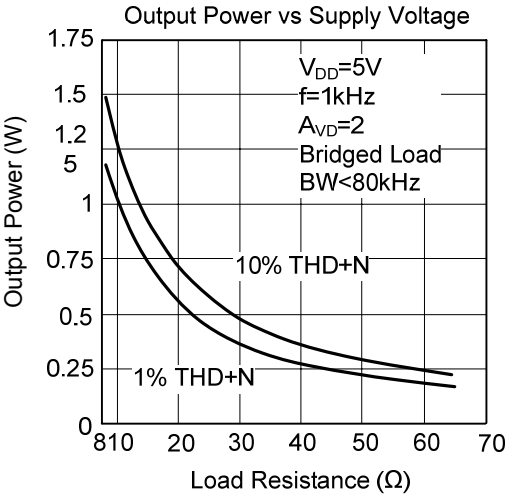
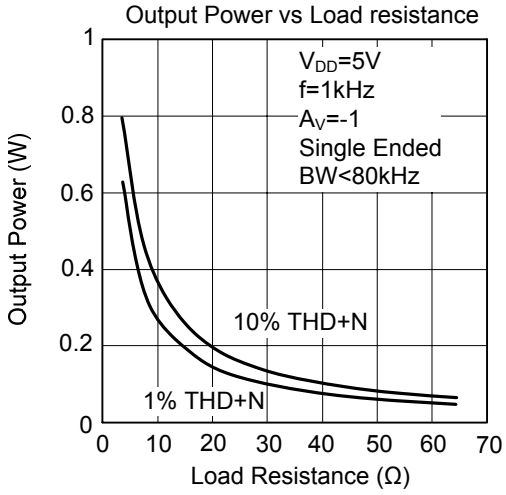
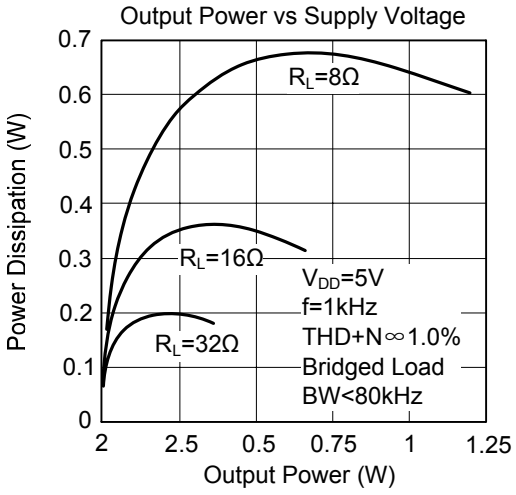




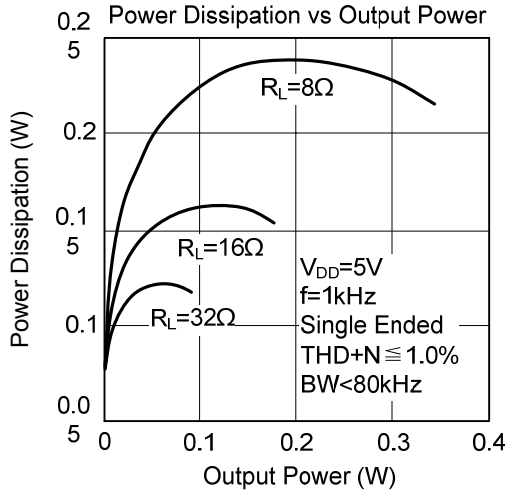


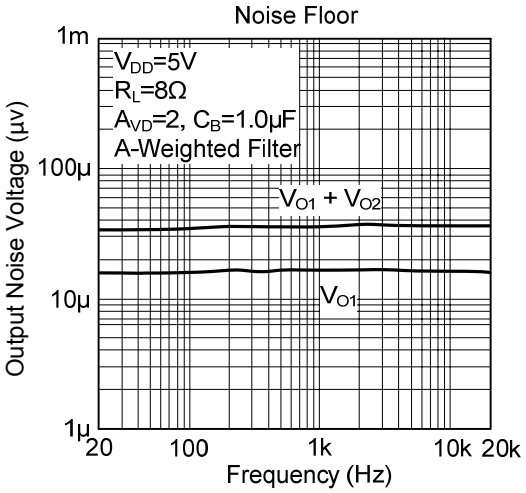


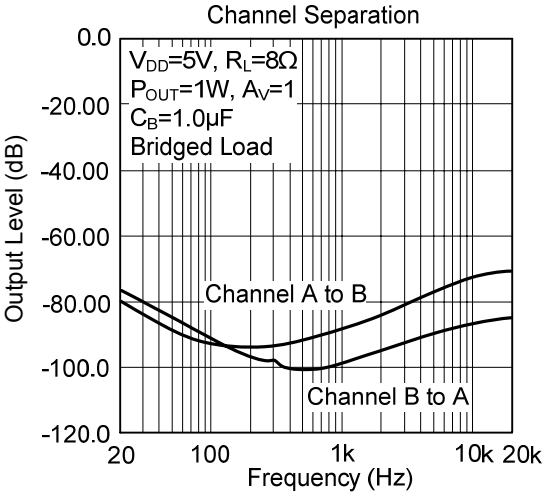


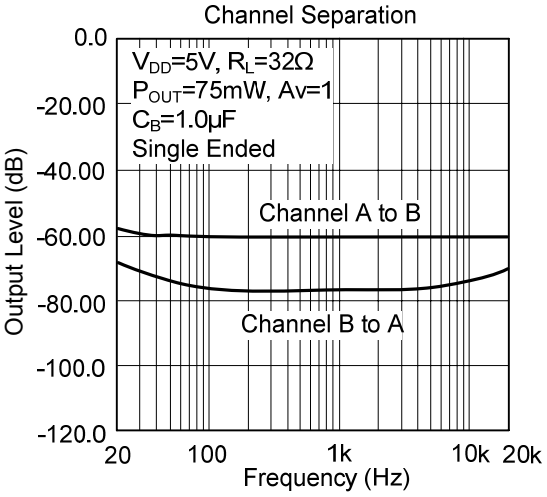


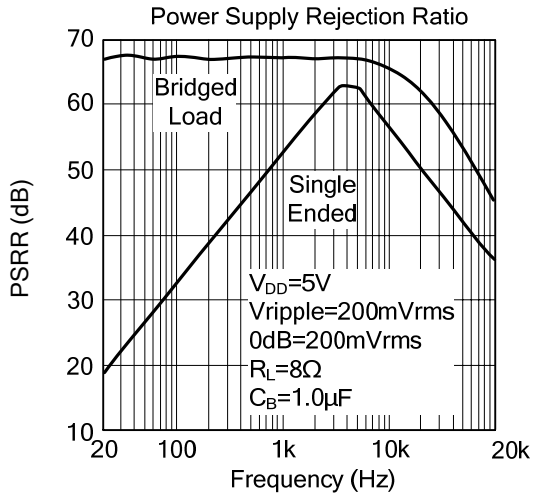
■ TYPICAL CHARACTERISTICS(Cont.)

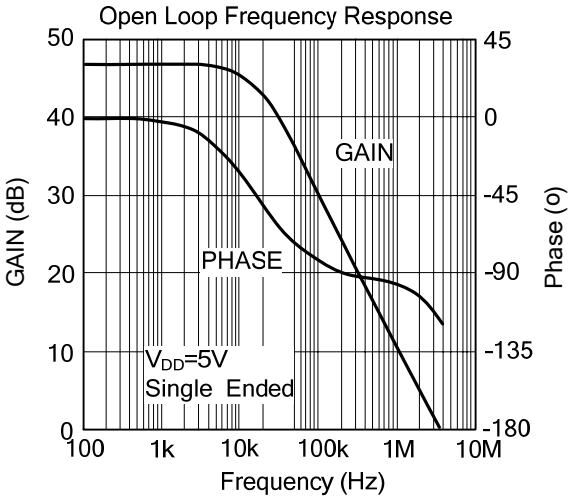












■ TYPICAL CHARACTERISTICS(Cont.)